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**APPLICANTS**

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**\*\* CONTINUING DATA \*\*\*\*\***  
 This application is a DIV of 10/028,263 12/28/2001 PAT 6,690,087 *Yes ml*

**\*\* FOREIGN APPLICATIONS \*\*\*\*\***  
 JAPAN 2000-402127 12/28/2000 *Yes ml*

**IF REQUIRED, FOREIGN FILING LICENSE GRANTED**  
**\*\* 10/21/2003**

Foreign Priority claimed 35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance	STATE OR COUNTRY JAPAN	SHEETS DRAWING 7	TOTAL CLAIMS 3	INDEPENDENT CLAIMS 2
Verified and Acknowledged	Examiner's Signature _____ Initials _____				

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**TITLE**  
 Power semiconductor module

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